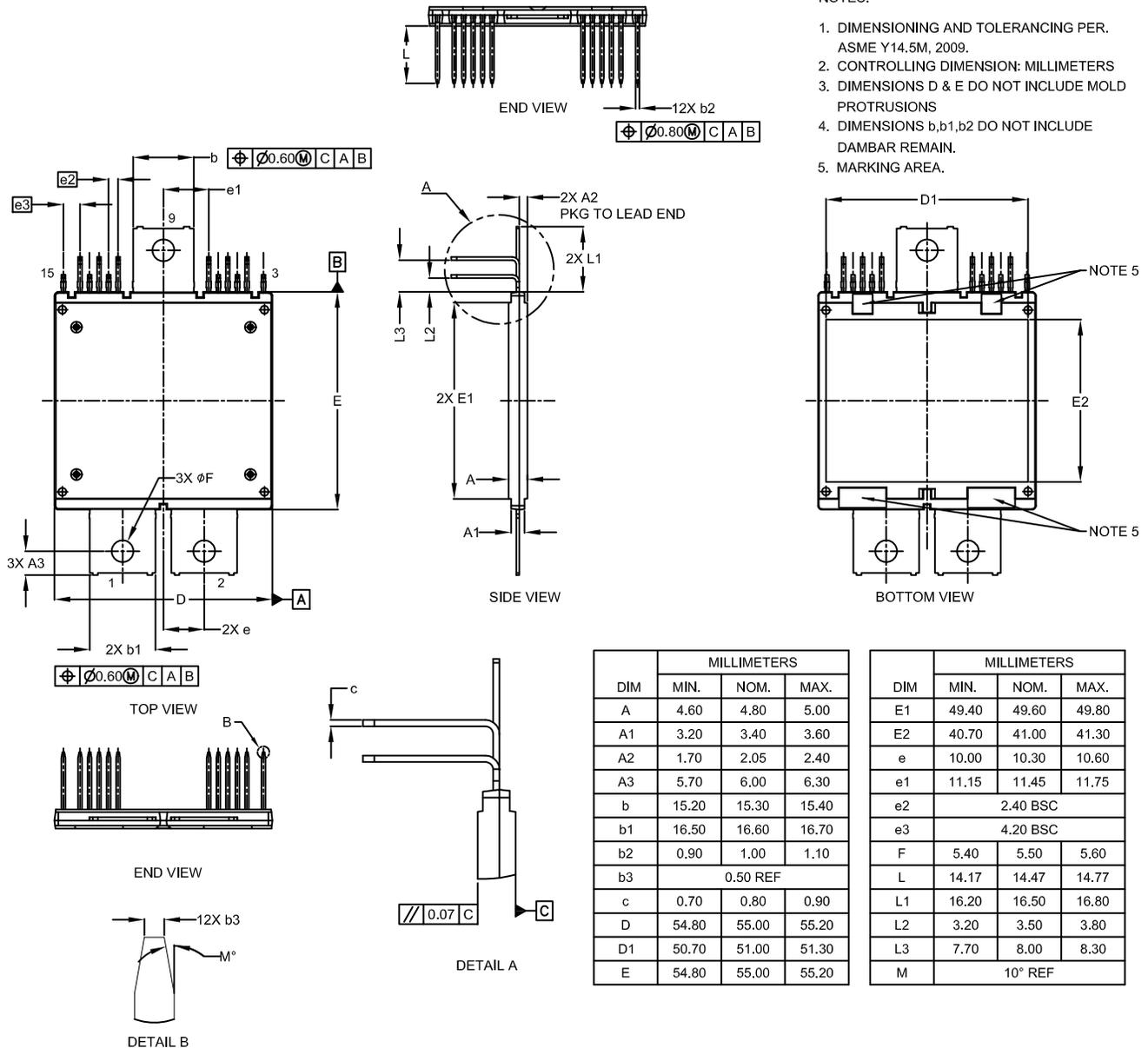


## AHPM15-CDE AUTOMOTIVE MODULE CASE MODHT ISSUE O

DATE 23 APR 2021

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E DO NOT INCLUDE MOLD PROTRUSIONS
4. DIMENSIONS b, b1, b2 DO NOT INCLUDE DAMBAR REMAIN.
5. MARKING AREA.



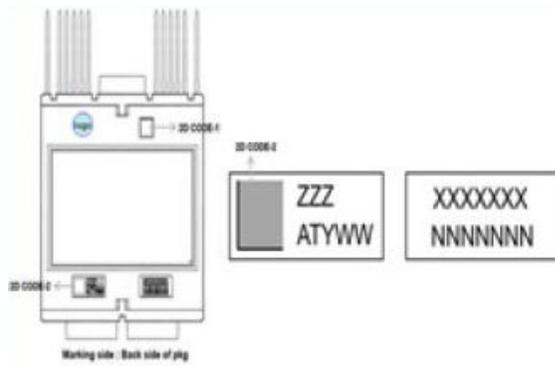
<b>DOCUMENT NUMBER:</b>	<b>98AON33310H</b>	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
<b>DESCRIPTION:</b>	<b>AHPM15-CDE AUTOMOTIVE MODULE</b>	<b>PAGE 1 OF 2</b>

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**AHPM15-CDE AUTOMOTIVE MODULE**  
**CASE MODHT**  
**ISSUE O**

DATE 23 APR 2021

**GENERIC  
MARKING DIAGRAM\***



ZZZ = Assembly Lot Code  
AT = Assembly & Test Location  
Y = Year  
WW = Work Week  
XXXX = Specific Device Code  
NNNN = Serial Number

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "μ", may or may not be present. Some products may not follow the Generic Marking.

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<b>DESCRIPTION:</b>	<b>AHPM15-CDE AUTOMOTIVE MODULE</b>	<b>PAGE 2 OF 2</b>

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